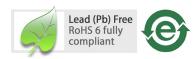
ASMT-MYA0

1W Power LED Light Source on MCPCB

Data Sheet





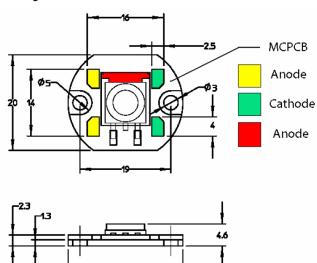


Description

Avago Technologies' 1W Warm White Power LED is a high performance energy efficient device which can handle high thermal and high driving current. The exposed pad design has excellent heat transfer from the package to the motherboard.

The Warm White Power LED is available in various color temperature ranging from 2600K to 4000K. The product has high Color Rendering Index (CRI) which provides excellent color perception and visual clarity.

Package Dimensions



Notes:

- 1. All dimensions in millimeters.
- 2. Tolerance is ± 0.1 mm unless otherwise specified.

Features

- Available in Warm White color.
- Energy efficient
- High current operation.
- Long operation life.
- Wide viewing angle.
- Silicone encapsulation

Specifications

- InGaN Technology
- 3.6V, 350 mA (typical)
- 110 viewing angle

Applications

- Portable (flash light, bicycle head light)
- Reading light
- Architectural lighting
- Garden lighting
- Decorative lighting

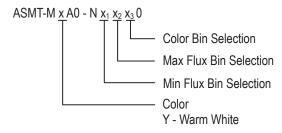
Device Selection Guide at Junction Temperature Tj = 25°C

		Luminous Flux, Φν ^[1,2,3] (lm)				
Color	Part Number	Min	Тур	Max	Test Current (mA)	Dice Technology
Warm White	ASMT-MYA0	43.0	50.0	73.0	350	InGaN

Notes:

- 1. Φ_V is the total luminous flux output as measured with an integrating sphere at 25ms mono pulse condition.
- 2. Flux tolerance is $\pm 10\%$
- 3. Φ_V data are only applicable for ASMT-MY00 component level device only.

Part Numbering System



Absolute Maximum Ratings^[3] at $T_A = 25$ °C

Parameter	ASMT-MYA0	Units
DC Forward Current [1]	350	mA
Peak Pulsing Current [2]	500	mA
Power Dissipation	1400	mW
LED Junction Temperature	110	°C
Operating Ambient Temperature Range	-40 to +85	°C
Storage Temperature Range	-40 to +100	°C

Note:

- 1. DC forward current derate linearly based on Figure 5.
- 2. Pulse condition duty factor = 10%, Frequency = 1kHz.
- 3. Absolute Maximum Rating data are only applicable for ASMT-MY00 component level device only.

Optical Characteristics^[2] ($T_A = 25$ °C)

		Correlated (Temperatur	Color re, CCT (Kelvin)	Viewing Angle 20 (Degrees)	15 [1] Luminous Efficiency (lm/W)
Part Number	Color	Min	Max	Тур	Тур
ASMT-MYA0	Warm White	2600	4000	110	40

Notes:

- 1. θ ½ is the off-axis angle where the luminous intensity is ½ the peak intensity.
- 2. Optical Characteristics data are only applicable for ASMT-MY00 component level device only.

Electrical Characteristic^[3] ($T_A = 25$ °C)

	Forward Vo	oltage V _F (Volts) @ I _F = 350mA		Thermal Resistance R _{0j-b} (°C/W) [2]	
Dice Type	Тур	Max.	Reverse Voltage V _R ^[1]	Тур.	
InGaN	3.6	4.0	Not recommended	18	

Note:

- 1. Not designed for reverse bias operation.
- 2. $R_{\theta j-b}$ is Thermal Resistance from LED junction to MCPCB.
- 3. Electrical Characteristic data are only applicable for ASMT-MY00 component level device only.

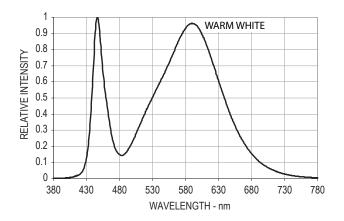


Figure 1. Relative intensity vs. wavelength

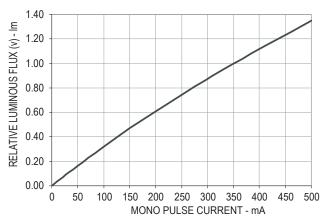


Figure 3. Relative Luminous Flux vs. Mono Pulse Current

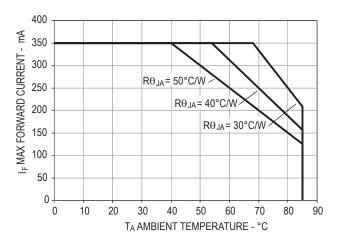


Figure 5. Maximum forward current vs. ambient temperature Derated based on T_JMAX = 110° C, R θ_{JA} = 30° C/W / 40° C/W and 50° C/W

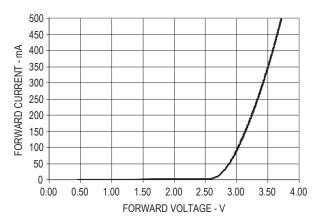


Figure 2. Forward Current vs Forward Voltage

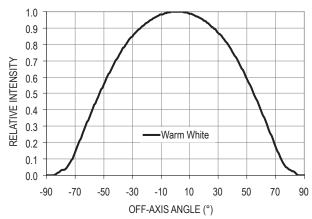


Figure 4. Radiation Pattern

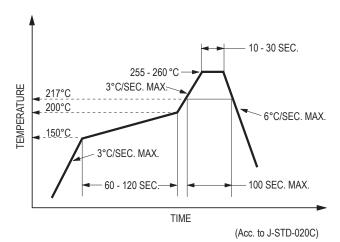


Figure 6. Recommended Reflow Soldering

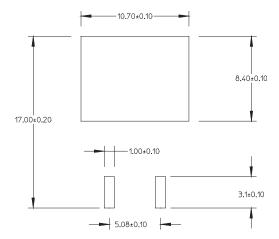


Figure 7. Recommended soldering land pattern

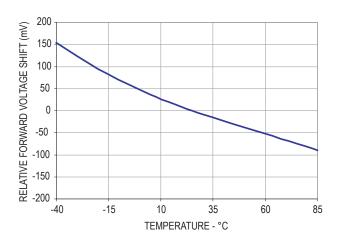


Figure 8. Temperature vs. relative forward voltage shift

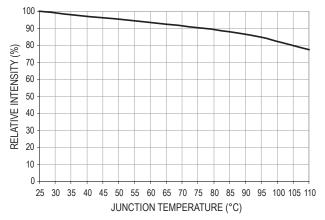


Figure 9. Relative LOP vs. junction temperature

Note: All parametric charts are only applicable for ASMT-MY00 component level device only.

Color Bin Selections [X₃]

Individual reel will contain parts from one full bin only.

0	Full Distribution
Α	A only
В	B only
С	C only
D	D only
Е	E only
F	F only
Z	A and B only
Υ	B and C only
W	C and D only
V	D and E only
U	E and F only
Q	A, B and C only
P	B, C and D only
N	C, D and E only
М	D, E and F only
J	Special Color Bin
1	A, B, C and D only
2	E, F, G and H only
3	B, C, D and E only
4	C, D, E and F only
5	A, B, C, D and E only
6	B, C, D, E, and F only

0.48 0.46 0.44 0.42 0.40 0.38 2.6k Black Body Curve 0.36 0.34 0.34 0.36 0.38 0.40 0.42 0.44 0.46 0.48 0.50 0.52 X - COORDINATE

Note:

Flux Bin Limit^[1] (For reference only) $[X_1, X_2]$

	Flux (Im) at 350mA			
Bin	Min	Max		
J	43.0	56.0		
K	56.0	73.0		

Tolerance for each bin limits is $\pm 10 \%$

Note

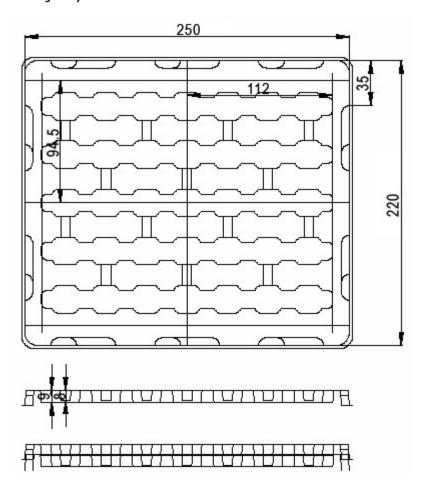
 Flux Bin Limit is only applicable for ASMT-MY00 component level device only

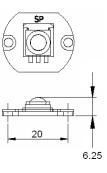
White	Color Limits (Chromaticity Coordinates)						
	Χ	0.452	0.488	0.470	0.438		
Bin A	Υ	0.434	0.447	0.414	0.403		
	Χ	0.438	0.470	0.452	0.424		
Bin B	Υ	0.403	0.414	0.384	0.376		
	Χ	0.407	0.418	0.452	0.438		
Bin C	Υ	0.393	0.422	0.434	0.403		
	Χ	0.395	0.407	0.438	0.424		
Bin D	Υ	0.362	0.393	0.403	0.376		
	Χ	0.381	0.387	0.418	0.407		
Bin E	Υ	0.377	0.404	0.422	0.393		
	Χ	0.373	0.381	0.407	0.395		
Bin F	Υ	0.349	0.377	0.393	0.362		

Tolerances ± 0.01

Color Limit and Color binning chart are only applicable for ASMT-MY00 component level device only

Package Tray Dimensions





Handling Precaution

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body (white plastic).

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